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JC515 U.S. PTO
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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original document or copy thereof.

1. Names of conveying party(ies):

Shigeru KINPARA
Yoshiyuki SATO
Hisayoshi OSUMI
Senji SUZUKI

Individuals

Additional names(s) of conveying party(ies) attached? NO

2. Name and Address of receiving party(ies):

Yamaha Corporation
10-1, Nakazawa-cho, Hamamatsu-shi
Shizuoka-ken, Japan

Corporation of Japan

Additional name(s) & address(es) attached? NO

3. Nature of conveyance:

Assignment

Execution Date: April 27, 1999 and
May 17, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: April 27, 1999
and May 17, 1999

A. Application No.(s) 09/330,919

B. Patent No.(s)

Additional numbers attached? NO

5. Name and address of party to whom
correspondence concerning document should
be mailed:

OSTROLENK, FABER, GERB & SOFFEN, LLP
1180 Avenue of the Americas
New York, New York 10036-8403

6. Total number of documents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00

Enclosed as part of Check No. 85393

In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee due is not paid, the Patent and Trademark Office is authorized to charge the underpayment to Deposit Account No. 15-0700.

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8. To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Steven I. Weisburd
Name of Person Signing

Signature

June 11, 1999
Date

Total number of pages including cover sheet, attachments, and document: 2

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06/23/1999 JWSHINE
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PATENT
REEL: 010045 FRAME: 0092

WHEREAS, I (We), (1) Shigeru Kinpara; (2) Yoshiyuki Sato; (3) Hisayoshi Osumi; and (4) Senji Suzuki as assignor(s), have invented certain improvements in
METHOD FOR MANUFACTURING HEAT-CURABLE RESIN MOLDED PRODUCT

for which an application for United States Letters Patent has been executed by me (us) of even date herewith; and

WHEREAS, YAMAHA CORPORATION of 10-1, Nakazawa-cho, Hamamatsu-shi, Shizuoka-ken, Japan

as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: Apr. 27. 1999

Shigeru Kinpara Shigeru Kinpara

Date: May. 17. 1999

Yoshiyuki Sato Yoshiyuki Sato

Date: May. 17. 1999

Hisayoshi Osumi Hisayoshi Osumi

Date: May. 17. 1999

Senji Suzuki Senji Suzuki

LEGALIZATION RECOMMENDED